

Is Now Part of

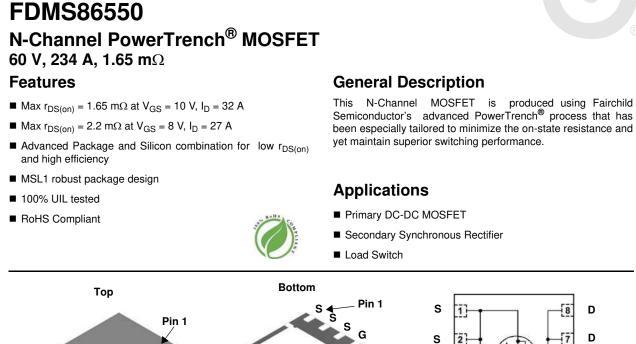


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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Power 56

Symbol	Parameter Drain to Source Voltage			Ratings	Units V	
V _{DS}				60		
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	234	A	
	-Continuous	T _C = 100 °C	(Note 5)	148		
	-Continuous	T _A = 25 °C	(Note 1a)	32		
	-Pulsed		(Note 4)	1021		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	937	mJ	
P _D	Power Dissipation	er Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		156	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.7	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/ W

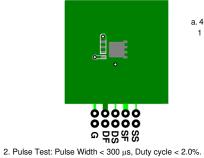
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86550	FDMS86550	Power 56	13 "	12 mm	3000 units

FDMS86550
N-Channel
PowerTrench
[®] MOSFET

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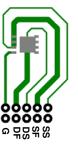
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		31		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.5	3.3	4.5	V
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-12		mV/°C
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}$		1.4	1.65	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 8 \text{ V}, \text{ I}_{D} = 27 \text{ A}$		1.7	2.2	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		2.2	2.6	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 32 A		96		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			8235	11530	pF
C _{oss}	Output Capacitance	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V},$		2140	3000	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		70	120	pF
R _g	Gate Resistance		0.1	0.9	2.7	Ω
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			43	69	ns
t _r	Rise Time	V _{DD} = 30 V, I _D = 32 A,		27	43	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		42	67	ns
t _f	Fall Time			11	20	ns
Q _g	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		110	154	nC
Q _q	Total Gate Charge	$V_{GS} = 0 \text{ V to } 8 \text{ V} \text{ V}_{DD} = 30 \text{ V},$		90	126	nC
Q _{qs}	Gate to Source Charge	I _D = 32 A		40		nC
Q _{gd}	Gate to Drain "Miller" Charge			20		nC
Drain-Sou	urce Diode Characteristics					
.,	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.1 A (Note 2)		0.7	1.2	
V_{SD}		$V_{GS} = 0 V, I_S = 32 A$ (Note 2)		0.8	1.3	V
t _{rr}	Reverse Recovery Time			68	109	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 32 A, di/dt = 100 A/μs		62	99	nC



4. Pulsed Id please refer to Fig 11 SOA graph for more details.

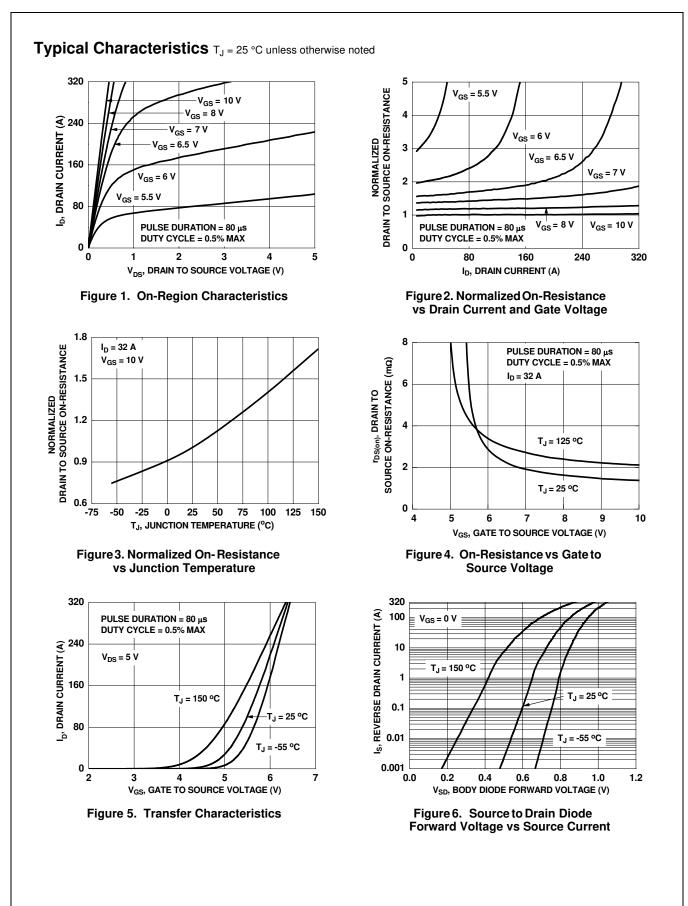
a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.

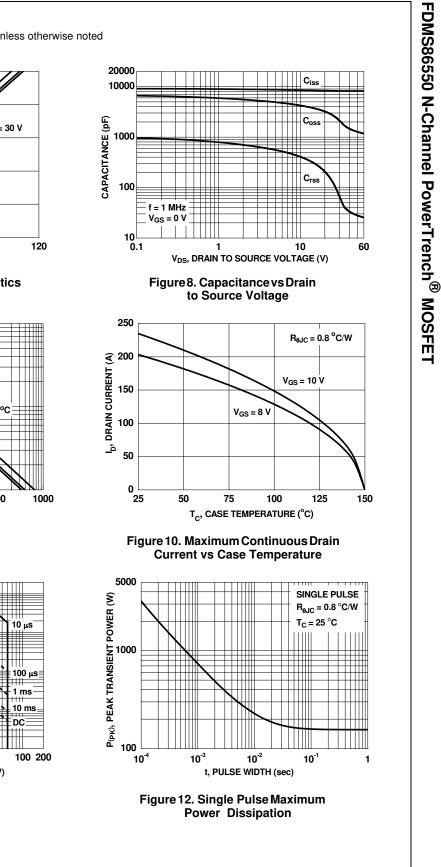
3. E_{AS} of 937 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 25 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 79 A.

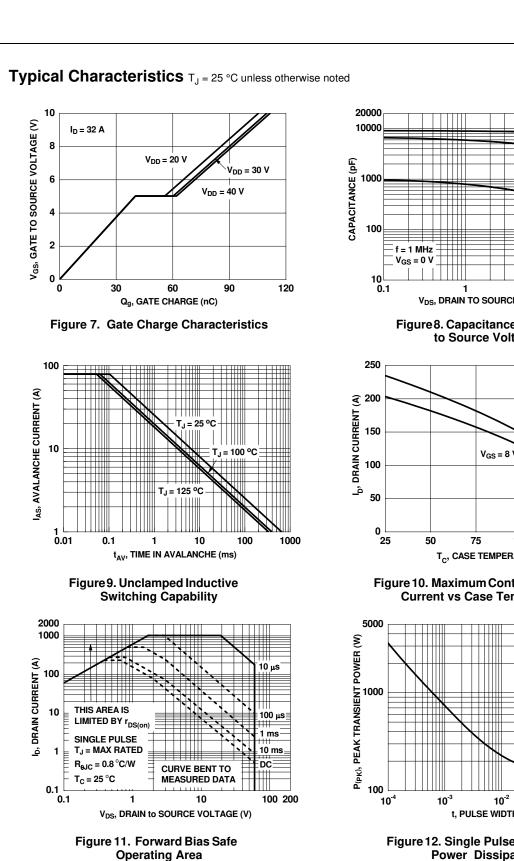


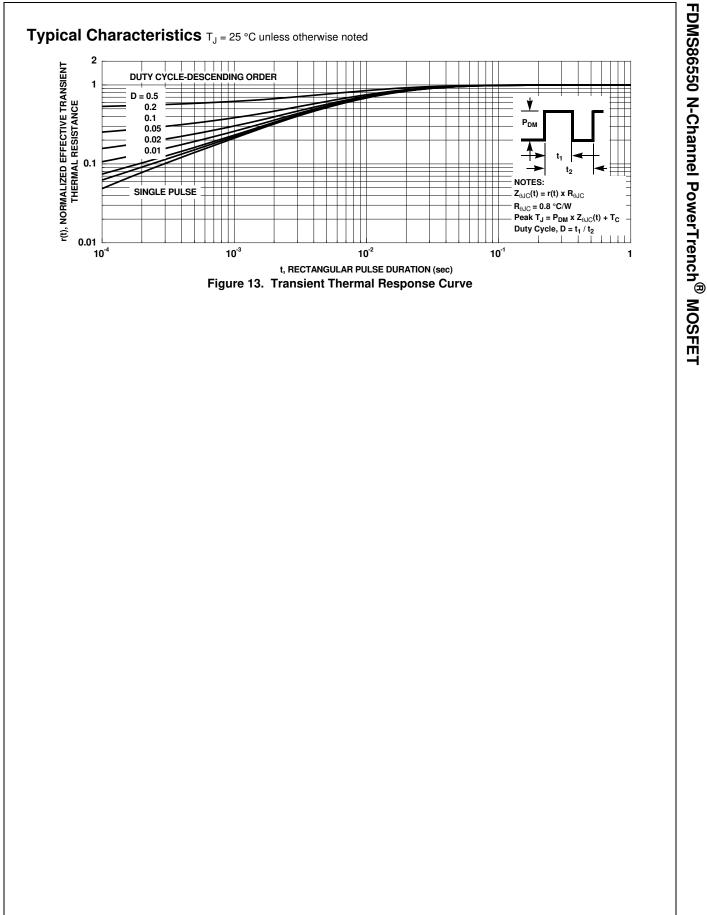
b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

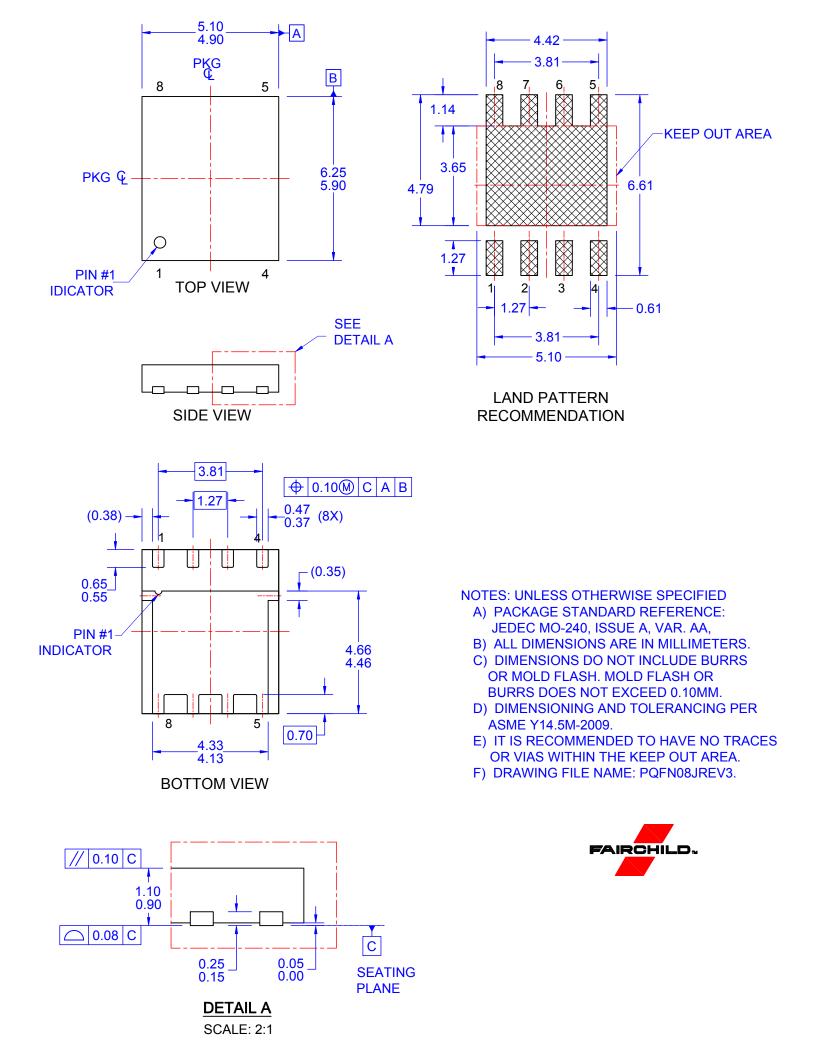
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.











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